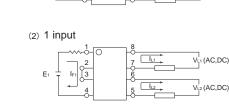
® 2 Form A **APW217S** APSEMI SOP-8 Load Voltage: 200V Load Current: 180mA TSCA UPDATE Parameter Symbol Rating Units E534710 V Load Voltage V∟ 200 Load Current IL. 0.18 А 5 On-Resistance Ron Ω I/O Breakdown Voltage V/ıo Vrms 2500 (1) 2 input (+) V_{L1}^I (AC,DC) E $I_{E^{\dagger}}$ IL2 VL2 (AC,DC) (-) Input IF2



APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

switching

•

•

(-/+)

(+) Input

(-) Input

1,3. LED Anode 2,4. LED Cathode 5,6. Drain (MOS FET) 7,8. Drain (MOS FET)

• Long life (No limit on mechanical and electrical

SOP-8

- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

Applications

These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching .
- Multiplexers •
- Meter reading systems •
- Data acquisition
- Medical equipment .
- Battery monitoring •
- I/O Sub-Systems •

Small package size

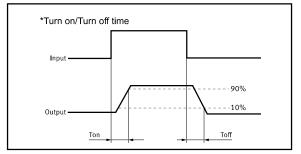
- •
- Reed Relay EMR Replacement •

• No have voltaic arc, bounce, and noise More

resistant to vibration and impact AC or DC load

TPYES

	Category	Output Rating		Package	Part No.	Pooking Quantity	
		Load Voltage	Load Current	Гаскаде	Fall NO.	Packing Quantity	
	AC/DC	200V	0.18A	SOP-8	APW217S	2000pcs /reel	



- Robotics • Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Programmable Controllers

Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Va l ue	Units	Note	
	Continuous LED Current	F	50	mA		
Input	Peak LED Current	IFP	1000	mA	f=100Hz, duty=1%	
	LED Reverse Voltage	VR	5	V		
	Input Power Dissipation	Pin	75	mW		
	Load Voltage	VL	200	V(AC peak or DC)		
	Load Current	L	0.18	A		
Output	Peak Load Current	Peak	0.50	А	100ms (1 pulse)	
	Output Power Dissipation	Pout	450	mW		
Total Power Dissipation		Ρτ	500	mW		
I/O Breakdown Voltage		Vi/o	2500	Vrms	RH=60%, 1min	
Operating Temperature		Topr	-40 to 85	°C		
Storage Temperature		Tstg	-40 to 100	C		
Pin Soldering Temperature		Tsol	260	C	10 sec max.	

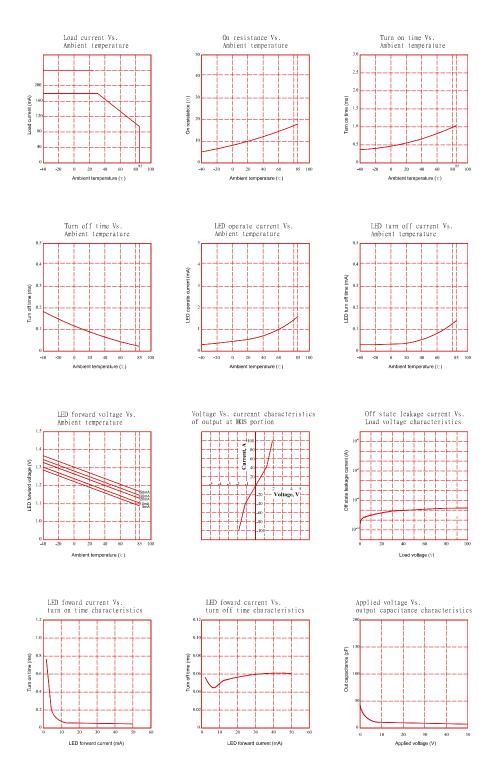
Electrical Characteristics (Ta = 25°C)

Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions	
	LED Forward Voltage	VF		1.2	1.4	V	l⊧=10mA	
	Operation LED Current	Fon		0.5	2.0	mA		
Input	Recovery LED Current	Foff		0.35	0.5	mA		
	Recovery LED Voltage		0.7			V		
							l⊧=5mA,l⊾=100mA,	
	On-Resistance	Ron		5	8	Ω	Time to flow is within 1 sec.	
Output	Off-State Leakage Current	Leak	0.01	0.02	0.1	uA	V₋=Rating	
	Output Capacitance	Cout		70		pF	V∟=0, f=1MHz	
Transmis	Turn-On Time	Ton		0.4	0.8	ms	l⊧=5mA, l∟=100mA,	
sion	Turn-Off Time	Toff		0.05	0.2	ms		
Coupled	I/O Isolation Resistance	Ri⁄o	10 ¹⁰			Ω	DC500V	
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz	

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

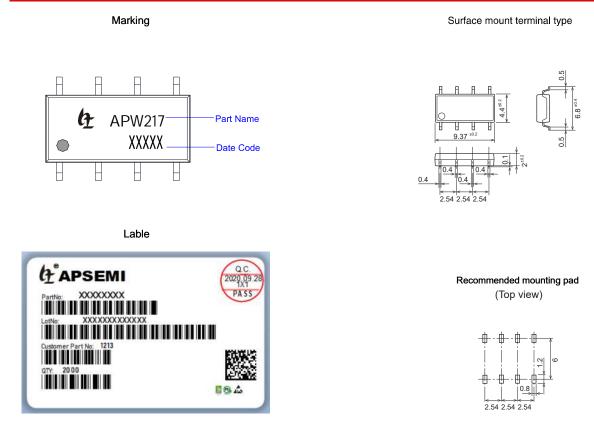


Engineering Data

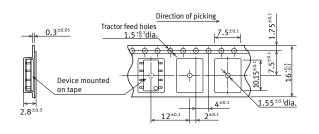




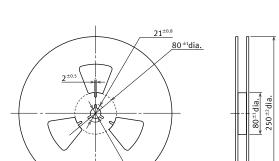
Dimensions and SOP-8 Package Unit: mm



Tape dimensions (tape reel)



Tape dimensions (Unit: mm)



Dimensions of paper tape reel (Unit: mm)

*Quality of material: Paper

13^{±0.5}dia.

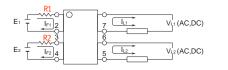
17.5^{±1.5}

2^{±1}



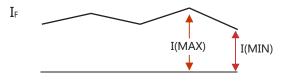
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

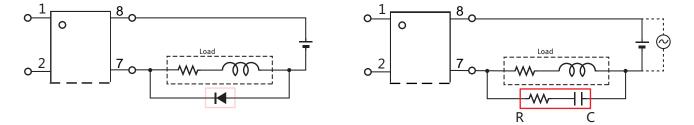
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	١ _F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

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